# AT24C16C

# **Atmel**

### I<sup>2</sup>C-Compatible, (2-Wire) Serial EEPROM 16-Kbit (2048 x 8)

### DATASHEET

### **Standard Features**

- Low-voltage and Standard-voltage Operation
  V<sub>CC</sub> = 1.7V to 5.5V
- Internally Organized as 2,048 x 8 (16K)
- I<sup>2</sup>C-compatible (2-wire) Serial Interface
- Schmitt Trigger, Filtered Inputs for Noise Suppression
- Bidirectional Data Transfer Protocol
- 1MHz (2.5V, 2.7V, 5V), 400kHz (1.7V) Compatibility
- Write Protect Pin for Hardware Data Protection
- 16-byte Page Write Mode
  - Partial Page Writes Allowed
- Self-timed Write Cycle (5ms Max)
- High-reliability
  - Endurance: 1,000,000 Write Cycles
  - Data Retention: 100 Years
- Green Package Options (Pb/Halide-free/RoHS Compliant)
  - 8-lead PDIP, 8-lead SOIC, 8-lead TSSOP, 8-pad UDFN, 8-pad XDFN, 5-lead SOT23, and 8-ball VFBGA
- Die Options: Wafer Form and Tape and Reel

#### **Description**

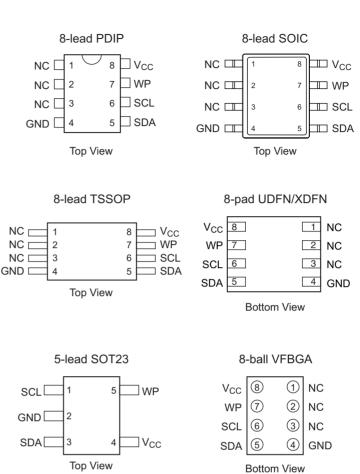
The Atmel<sup>®</sup> AT24C16C provides 16,384 bits of Serial Electrically Erasable and Programmable Read-Only Memory (EEPROM) organized as 2,048 words of 8 bits each. The device is optimized for use in many industrial and commercial applications where low-power and low-voltage operation are essential. AT24C16C is available in space-saving 8-lead PDIP, 8-lead JEDEC SOIC, 8-lead TSSOP, 8-pad UDFN, 8-pad XDFN, 5-lead SOT23, and 8-ball VFBGA packages and is accessed via a 2-wire serial interface.

#### **Pin Configurations and Pinouts** 1.

**Pin Configuration** 

Table 1.

Pin Name	Function
NC	No Connect
SDA	Serial Data
SCL	Serial Clock Input
WP	Write Protect
GND	Ground
V <sub>CC</sub>	Power Supply





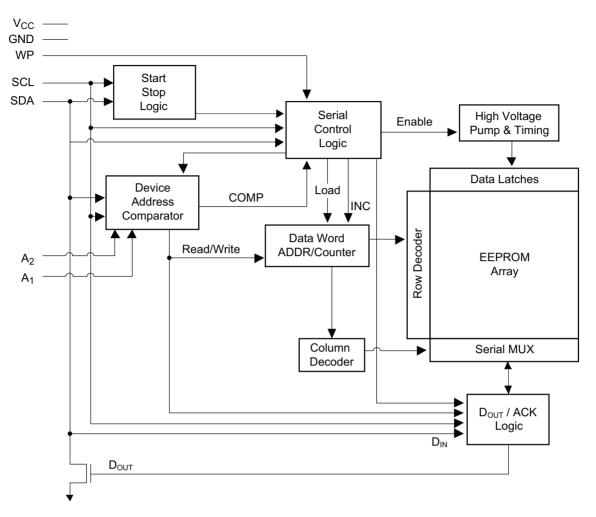
#### **Absolute Maximum Ratings** 2.

Operating Temperature55°C to +125°C
Storage Temperature65°C to +150°C
Voltage on any pin with respect to ground1.0V to +7.0V
Maximum Operating Voltage 6.25V
DC Output Current

*Notice:	Stresses beyond those listed under "Absolute
	Maximum Ratings" may cause permanent damage
	to the device. This is a stress rating only and
	functional operation of the device at these or any
	other conditions beyond those indicated in the
	operational sections of this specification is not
	implied. Exposure to absolute maximum rating
	conditions for extended periods may affect device
	reliability.



### 3. Block Diagram



### 4. Pin Description

Serial Clock (SCL): The SCL input is used to positive edge clock data into each EEPROM device and negative edge clock data out of each device.

**Serial Data (SDA):** The SDA pin is bidirectional for serial data transfer. This pin is open-drain driven and may be wire-ORed with any number of other open-drain or open-collector devices.

Device/Page Addresses: The AT24C16C does not use the device address pins, which limits the number of devices on a single bus to one (see Section 7. "Device Addressing" on page 9).

**Write Protect (WP):** AT24C16C has a Write Protect pin that provides hardware data protection. The Write Protect pin allows normal Read/Write operations when connected to Ground (GND). When the Write Protect pin is connected to  $V_{CC}$ , the Write Protection feature is enabled and operates as shown in Table 4-1.

WP Pin Status	Part of the Array Protected
At V <sub>CC</sub>	Full Array
At GND	Normal Read/Write Operations

#### Table 4-1. Write Protect

### 5. Memory Organization

**AT24C16C, 16K Serial EEPROM:** Internally organized with 128 pages of 16 bytes each, the 16K requires a 11-bit data word address for random word addressing.

### 5.1 Pin Capacitance

#### Table 5-1.Pin Capacitance<sup>(1)</sup>

Applicable over recommended operating range from  $T_A = 25^{\circ}C$ , f = 1.0MHz,  $V_{CC} = 5.5V$ .

Symbol	Test Condition	Мах	Units	Conditions
C <sub>I/O</sub>	Input/Output capacitance (SDA)	8	pF	V <sub>I/O</sub> = 0V
C <sub>IN</sub>	Input capacitance (A <sub>0</sub> , A <sub>1</sub> , A <sub>2</sub> , SCL)	6	pF	$V_{IN} = 0V$

Note: 1. This parameter is characterized and is not 100% tested.

### 5.2 DC Characteristics

#### Table 5-2. DC Characteristics

Applicable over recommended operating range from: T<sub>AI</sub> = -40°C to +85°C, V<sub>CC</sub> = 1.7V to 5.5V (unless otherwise noted).

Symbol	Parameter	Test Condition	Min	Тур	Мах	Units
V <sub>CC1</sub>	Supply Voltage		1.7		5.5	V
I <sub>CC</sub>	Supply Current $V_{CC}$ = 5.0V	Read at 100kHz		0.4	1.0	mA
I <sub>CC</sub>	Supply Current $V_{CC}$ = 5.0V	Write at 100kHz		2.0	3.0	mA
I <sub>SB1</sub>	Standby Current V <sub>CC</sub> = 1.7V	$V_{IN}$ = $V_{CC}$ or $V_{SS}$			1.0	μΑ
I <sub>SB2</sub>	Standby Current V <sub>CC</sub> = $5.5V$	$V_{IN}$ = $V_{CC}$ or $V_{SS}$			6.0	μΑ
ILI	Input Leakage Current	$V_{IN}$ = $V_{CC}$ or $V_{SS}$		0.10	3.0	μΑ
I <sub>LO</sub>	Output Leakage Current	$V_{OUT}$ = $V_{CC}$ or $V_{SS}$		0.05	3.0	μΑ
V <sub>IL</sub>	Input Low Level <sup>(1)</sup>		-0.6		V <sub>CC</sub> x 0.3	V
V <sub>IH</sub>	Input High Level <sup>(1)</sup>		V <sub>CC</sub> x 0.7		V <sub>CC</sub> + 0.5	V
V <sub>OL2</sub>	Output Low Level $V_{CC}$ = 3.0V	I <sub>OL</sub> = 2.1mA			0.4	V
V <sub>OL1</sub>	Output Low Level V <sub>CC</sub> = $1.7V$	I <sub>OL</sub> = 0.15mA			0.2	V

Note: 1.  $V_{IL}$  min and  $V_{IH}$  max are reference only and are not tested.



### 5.3 AC Characteristics

#### Table 5-3. AC Characteristics

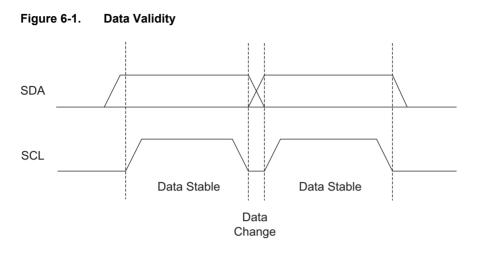
Applicable over recommended operating range from  $T_{AI}$  = -40°C to 85°C,  $V_{CC}$  = +1.7V to 5.5V, CL = 1TTL Gate and 100pF (unless otherwise noted).

		1.	7V	2.5V, 2.7	V, 5.0V	
Symbol	Parameter	Min	Max	Min	Мах	Units
f <sub>SCL</sub>	Clock Frequency, SCL		400		1000	kHz
t <sub>LOW</sub>	Clock Pulse Width Low	1.2		0.4		μs
t <sub>HIGH</sub>	Clock Pulse Width High	0.6		0.4		μs
t <sub>I</sub>	Noise Suppression Time		100		50	ns
t <sub>AA</sub>	Clock Low to Data Out Valid	0.1	0.9	0.05	0.55	μs
t <sub>BUF</sub>	Time the bus must be free before a new transmission can start.	1.2		0.5		μs
t <sub>HD.STA</sub>	Start Condition Hold Time	0.6		0.25		μs
t <sub>SU.STA</sub>	Start Condition Setup Time	0.6		0.25		μs
t <sub>HD.DAT</sub>	Data In Hold Time	0		0		μs
t <sub>SU.DAT</sub>	Data In Setup Time	100		100		ns
t <sub>R</sub>	Inputs Rise Time <sup>(1)</sup>		0.3		0.3	μs
t <sub>F</sub>	Inputs Fall Time <sup>(1)</sup>		300		100	ns
t <sub>SU.STO</sub>	Stop Condition Setup Time	0.6		.25		μs
t <sub>DH</sub>	Data Out Hold Time	50		50		ns
t <sub>WR</sub>	Write Cycle Time		5		5	ms
Endurance <sup>(1)</sup>	3.3V, 25°C, Page Mode		1,000	),000		Write Cycles

Note: 1. This parameter is ensured by characterization only.

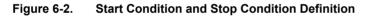
### 6. Device Operation

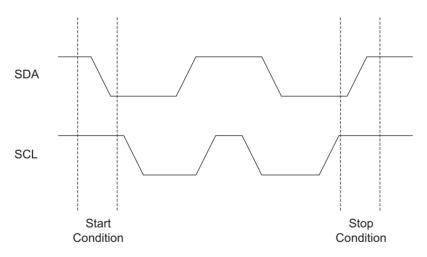
**Clock and Data Transitions:** The SDA pin is normally pulled high with an external device. Data on the SDA pin may change only during SCL low time periods. Data changes during SCL high periods will indicate a Start or Stop Condition as defined below.



**Start Condition:** A high-to-low transition of SDA with SCL high is a Start Condition which must precede any other command.

**Stop Condition:** A low-to-high transition of SDA with SCL high is a Stop Condition. After a read sequence, the Stop Condition command will place the EEPROM in a standby power mode.

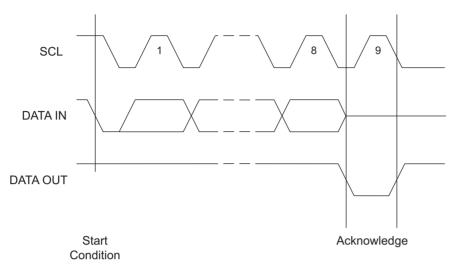






**Acknowledge:** All addresses and data words are serially transmitted to and from the EEPROM in eight bit words. The EEPROM sends a zero to acknowledge that it has received each word. This happens during the ninth clock cycle.





Standby Mode: The AT24C16C features a low-power standby mode which is enabled:

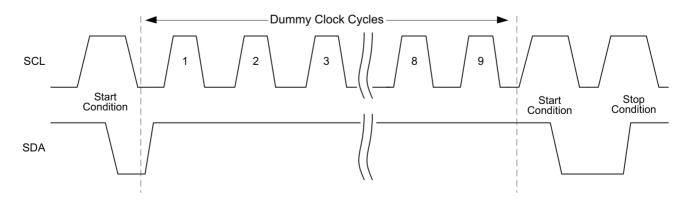
- Upon power-up.
- After the receipt of the Stop Condition and the completion of any internal operations.

**2-wire Software Reset:** After an interruption in protocol, power loss or system reset, any 2-wire part can be reset by following these steps:

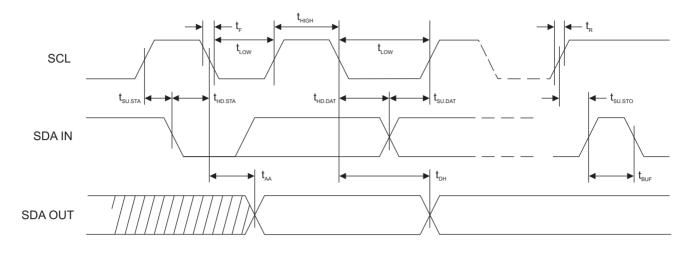
- 1. Create a Start Condition (if possible).
- 2. Clock nine cycles.
- 3. Create another Start Condition followed by Stop Condition as shown below.

The device should be ready for the next communication after above steps have been completed. In the event that the device is still non-responsive or remains active on the SDA bus, a power cycle must be used to reset the device.

#### Figure 6-4. Software Reset



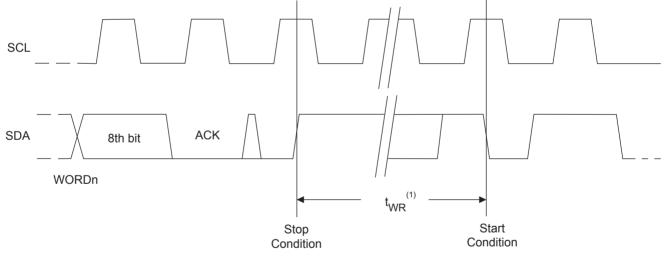
#### Figure 6-5. Bus Timing



SCL: Serial Clock, SDA: Serial Data I/O

#### Figure 6-6. Write Cycle Timing

SCL: Serial Clock, SDA: Serial Data I/O



Note: 1. The write cycle time  $t_{WR}$  is the time from a valid Stop Condition of a Write sequence to the end of the internal clear/write cycle.

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### 7. Device Addressing

**Standard EEPROM Access:** The 16K EEPROM device requires an 8-bit device address word following a Start Condition to enable the chip for a Read or Write operation. The device address word consists of a mandatory "1010" (Ah) sequence for the first four Most Significant Bits (MSB) as shown in Figure 10. on page 12. This is common to all the EEPROM devices.

The next three bits used for memory page addressing are the most significant bits of the data word address which follows.

The eighth bit of the device address is the Read/Write operation select bit. A Read operation is initiated if this bit is high and a Write operation is initiated if this bit is low.

Upon a compare of the device address, the EEPROM will output a zero. If a compare is not made, the chip will return to a standby state.

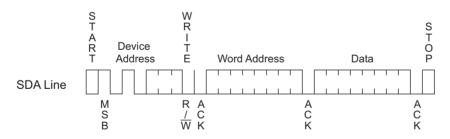
Figure 7-1.	Device Address
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Density	Access Area	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
16K	EEPROM	1	0	1	0	P2	P1	P0	R/W
		MSB			,		1		LSB

### 8. Write Operations

**Byte Write:** A Write operation requires an 8-bit data word address following the device address word and acknowledgment. Upon receipt of this address, the EEPROM will again respond with a zero and then clock in the first 8-bit data word. Following receipt of the 8-bit data word, the EEPROM will output a zero and the addressing device, such as a microcontroller, must terminate the Write sequence with a Stop Condition. At this time the EEPROM enters an internally timed write cycle, t<sub>WR</sub>, to the nonvolatile memory. All inputs are disabled during this write cycle and the EEPROM will not respond until the Write is complete.

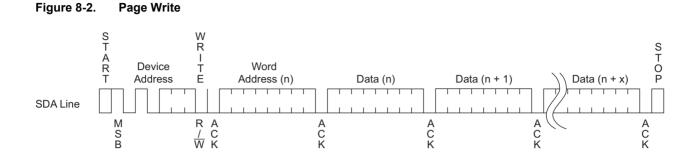
#### Figure 8-1. Byte Write



Page Write: The 16K EEPROM devices are capable of a 16-byte Page Write.

A Page Write is initiated in the same way as a Byte Write, but the microcontroller does not send a Stop Condition after the first data word is clocked in. Instead, after the EEPROM acknowledges receipt of the first data word, the microcontroller can transmit up to fifteen more data words. The EEPROM will respond with a zero after each data word received. The microcontroller must terminate the Page Write sequence with a Stop Condition (see Figure 8-2).

The data word address lower four bits are internally incremented following the receipt of each data word. The higher data word address bits are not incremented, retaining the memory page row location. When the word address, internally generated, reaches the page boundary, the following byte is placed at the beginning of the same page. If more than eight data words are transmitted to the EEPROM, the data word address will roll-over and previous data will be overwritten.



**Acknowledge Polling:** Once the internally timed write cycle has started and the EEPROM inputs are disabled, Acknowledge Polling can be initiated. This involves sending a Start Condition followed by the device address word. The Read/Write bit is representative of the operation desired. Only if the internal write cycle has completed will the EEPROM respond with a zero allowing the Read or Write sequence to continue.

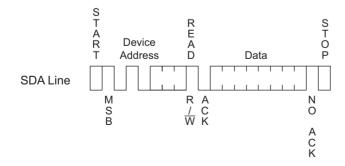
### 9. Read Operations

Read operations are initiated in the same way as Write operations with the exception that the Read/Write select bit in the device address word is set to one. There are three read operations:

- Current Address Read
- Random Address Read
- Sequential Read.

**Current Address Read:** The internal data word address counter maintains the last address accessed during the last Read or Write operation, incremented by one. This address stays valid between operations as long as the chip power is maintained. The address roll-over during Read is from the last byte of the last memory page to the first byte of the first page. The address roll-over during Write is from the last byte of the current page to the first byte of the same page.

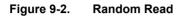
Once the device address with the Read/Write select bit set to one is clocked in and acknowledged by the EEPROM, the current address data word is serially clocked out. The microcontroller does not respond with an input zero but does generate a following Stop Condition (see Figure 9-1).

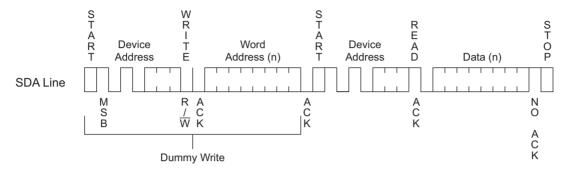


#### Figure 9-1. Current Address Read



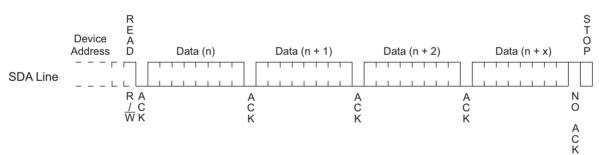
**Random Read:** A Random Read requires a Dummy Byte Write sequence to load in the data word address. Once the device address word and data word address are clocked in and acknowledged by the EEPROM, the microcontroller must generate another Start Condition. The microcontroller now initiates a Current Address Read by sending a device address with the Read/Write select bit high. The EEPROM acknowledges the device address and serially clocks out the data word. The microcontroller does not respond with a zero but does generate a following Stop Condition.



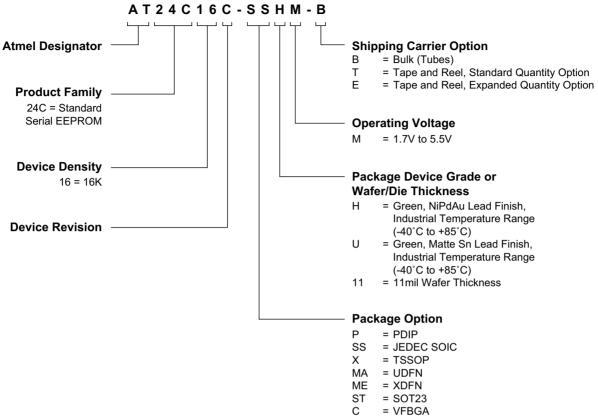


**Sequential Read:** Sequential Reads are initiated by either a Current Address Read or a Random Address Read. After the microcontroller receives a data word, it responds with an Acknowledge. As long as the EEPROM receives an Acknowledge, it will continue to increment the data word address and serially clock out sequential data words. When the memory address limit is reached, the data word address will roll-over and the Sequential Read will continue. The Sequential Read operation is terminated when the microcontroller does not respond with a zero but does generate a following Stop Condition.





### 10. Ordering Code Detail



WWU = Wafer Unsawn

# 11. Product Markings

8-lead PDIP	8-lead SOIC	;	8-lead TSSOP	8-r	pad UDFN
С. 25. 25. 2 АТМLUYWW ###% ААААААА С7 5.7 5.7 5.			ATHYWW ###% @ AAAAAAA	2.0 :	x 3.0 mm Body ### H응@ YXX ©
8-pad XDFN	5-lead SOT-	23	8-ball VFBGA		
1.8 x 2.2 mm Body ### YXX ●		E 9%U MXX	1.5 x 2.0 mm Body		
Catalog Number Trunca	odes before 7B, the bottom line (YMXX) i		side and there is no Country of Assembly (@)		
Note 2: Package drawings are not to sco Note 3: For SOT23 package with date of Catalog Number Trunca AT24C16C Date Codes	odes before 7B, the bottom line (YMXX) i	Truncatic	on Code ###: 16C / ##: A	C Voltages	3
Note 2: Package drawings are not to sci.        Note 3: For SOT23 package with date of        Catalog Number Trunca        AT24C16C        Date Codes        Y = Year        6: 2016      0: 2020        7: 2017      1: 2021        8: 2018      2: 2022	odes before 7B, the bottom line (YMXX) i	Truncatic	on Code ###: 16C / ##: A fork Week of Assembly k 2 k 4	C Voltages % =	
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# 12. Ordering Information

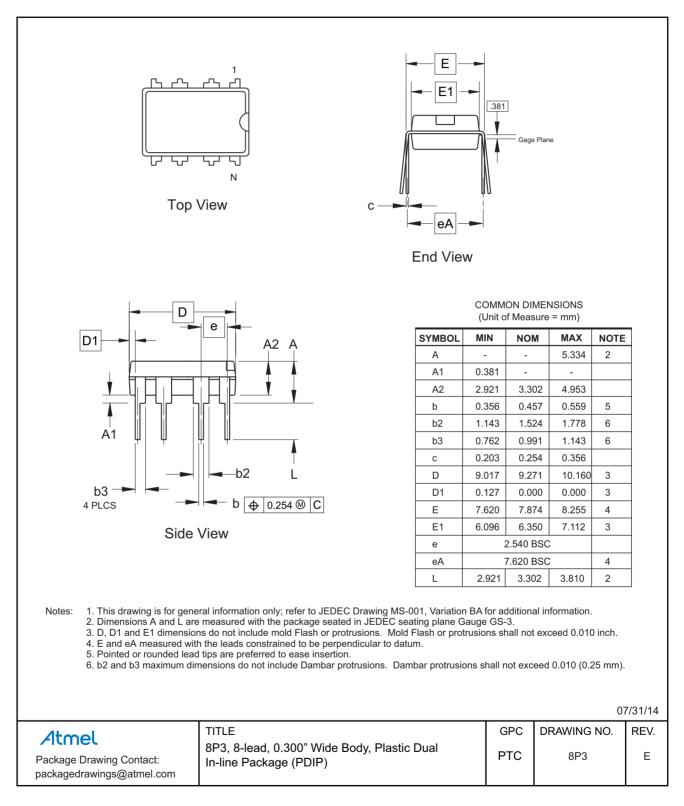
			Delivery I	Operation	
Atmel Ordering Code	Lead Finish	Package	Form	Quantity	Range
AT24C16C-SSHM-B		8S1	Bulk (Tubes)	100 per Tube	
AT24C16C-SSHM-T		001	Tape and Reel	4,000 per Reel	
AT24C16C-XHM-B	NiPdAu	8X	Bulk (Tubes)	100 per Tube	
AT24C16C-XHM-T	(Lead-free/Halogen-free)	lalogen-free)	Tape and Reel	5,000 per Reel	
AT24C16C-MAHM-T	-	8MA2	Tape and Reel	5,000 per Reel	
AT24C16C-MAHM-E		OWAZ	Tape and Reel	15,000 per Reel	Industrial Temperature (-40°C to 85°C)
AT24C16C-PUM	Matte Sn	8P3	Bulk (Tubes)	50 per Tube	· · · · ·
AT24C16C-STUM-T	(Lead-free/Halogen-free)	5TS1	Tape and Reel	5,000 per Reel	
AT24C16C-CUM-T	SnAgCu (Lead-free/Halogen-free)	8U3-1	Tape and Reel	5,000 per Reel	
AT24C16C-MEHM-T	N/A	8ME1	Tape and Reel	5,000 per Reel	
AT24C16C-WWU11M <sup>(1)</sup>	N/A	Wafer Sale	No	ote 1	

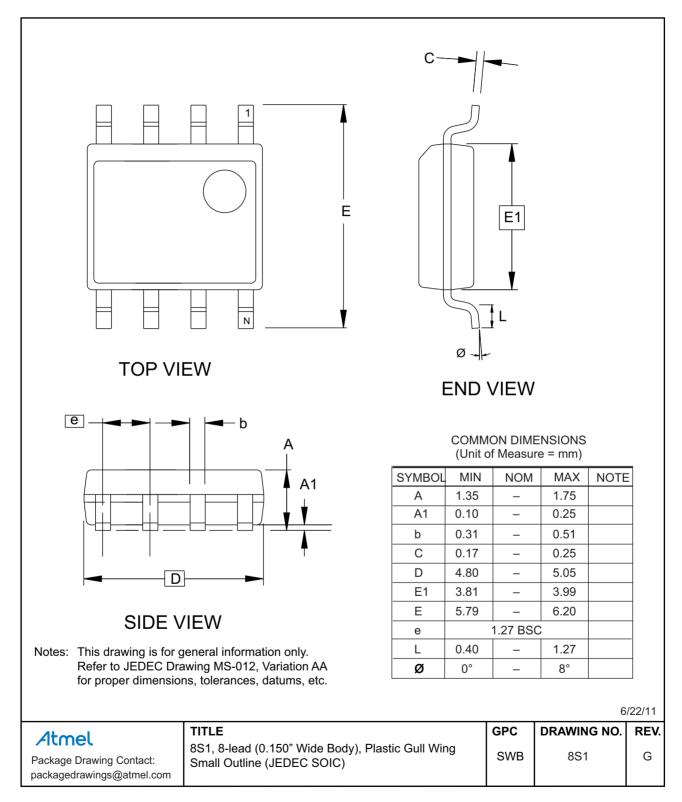
Note: 1. For Wafer sales, please contact Atmel Sales.

	Package Type
8P3	8-lead, 0.300" wide, Plastic Dual Inline Package (PDIP)
8S1	8-lead, 0.150" wide, Plastic Gull Wing Small Outline (JEDEC SOIC)
8X	8-lead, 4.40mm body, Plastic Thin Shrink Small Outline Package (TSSOP)
8MA2	8-pad, 2.00mm x 3.00mm body, 0.50mm pitch, Plastic Ultra Thin Dual Flat No Lead (UDFN)
8ME1	8-lead, 1.80mm x 2.20mm body, 0.40mm pitch, Extra Thin Dual Flat No Lead (XDFN)
5TS1	5-lead, 2.90mm x 1.60mm body, Plastic Thin Shrink Small Outline (SOT23)
8U3-1	8-ball, 1.50mm x 2.00mm body, 0.50mm pitch, Die Ball Grid Array (VFBGA)

### 13. Packaging Information

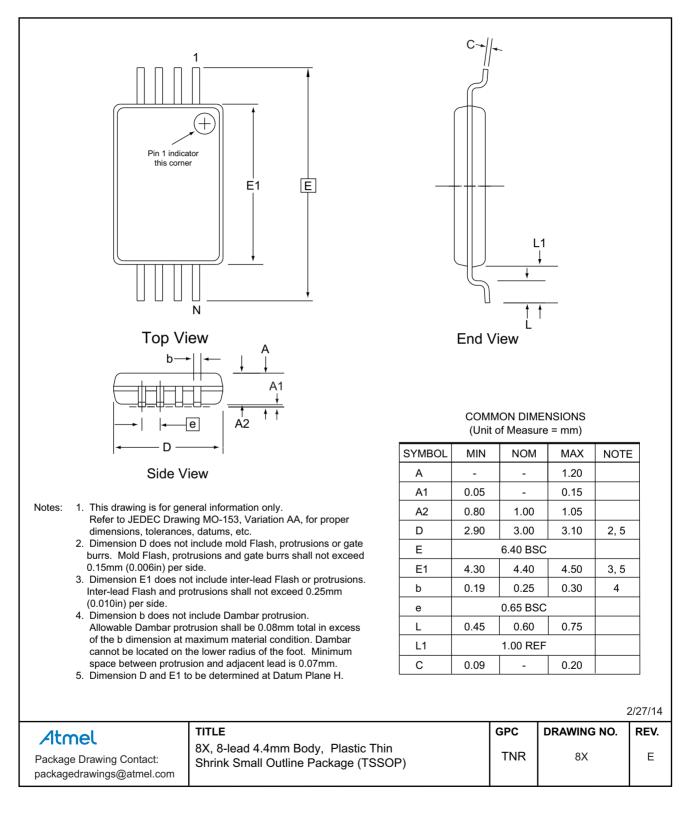
### 13.1 8P3 — 8-lead PDIP



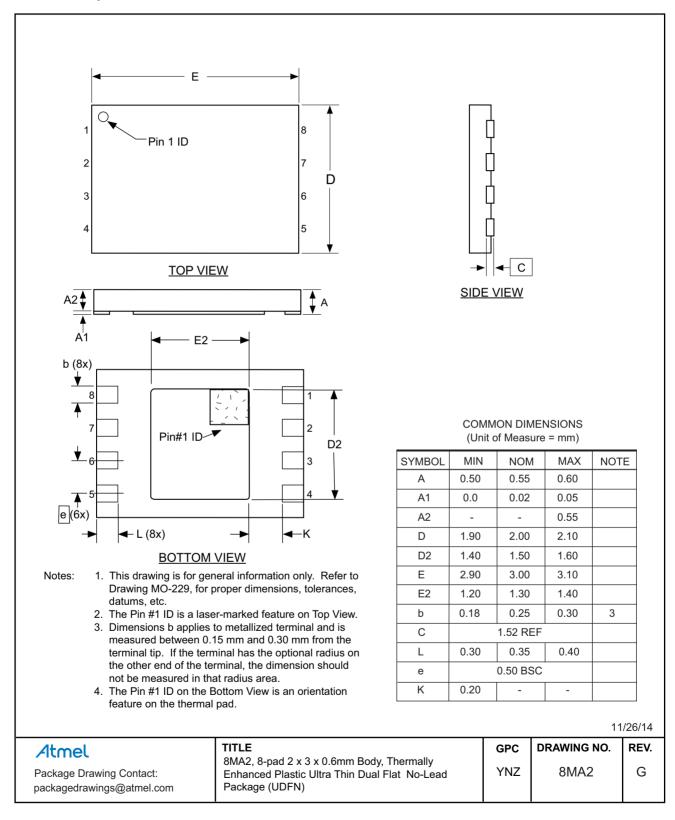




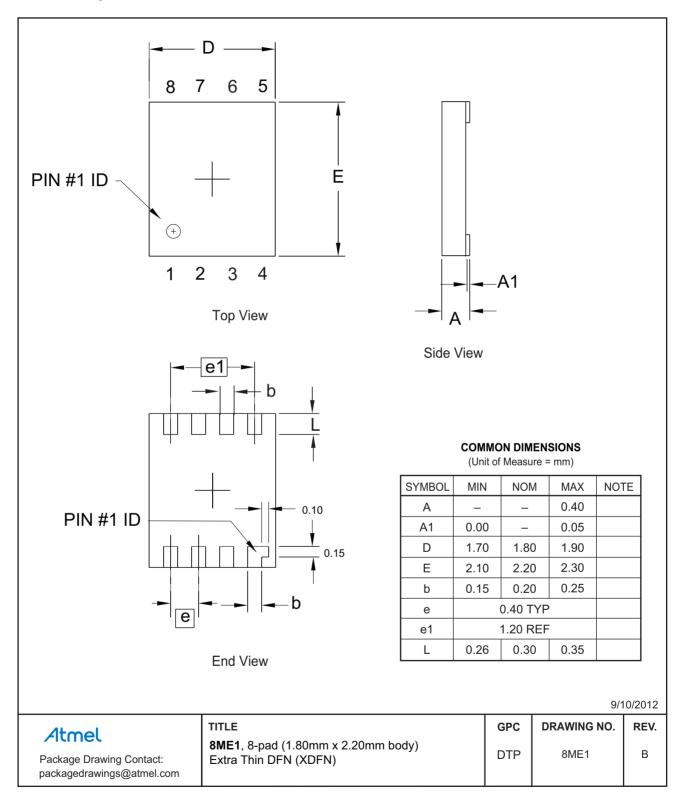
#### 13.3 8X — 8-lead TSSOP



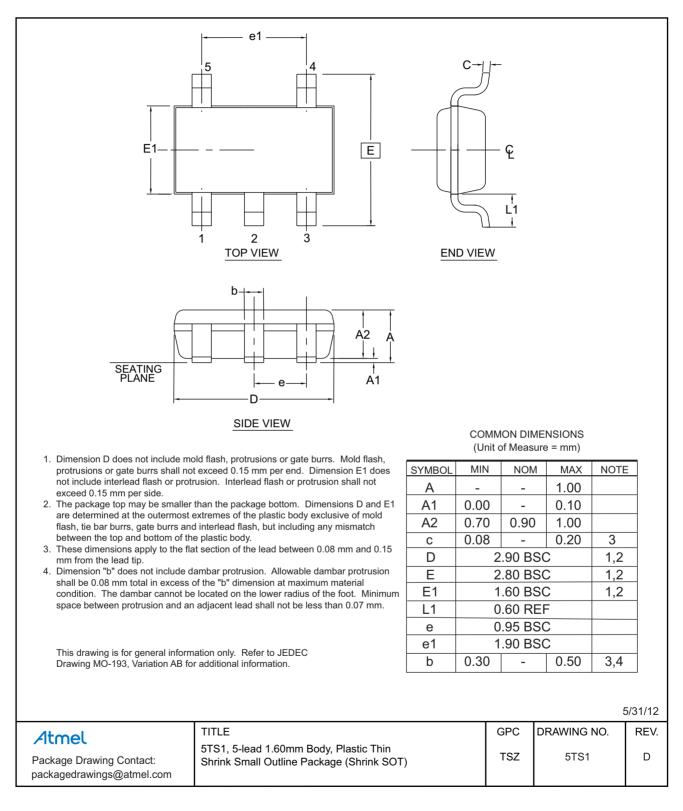
#### 13.4 8MA2 — 8-pad UDFN





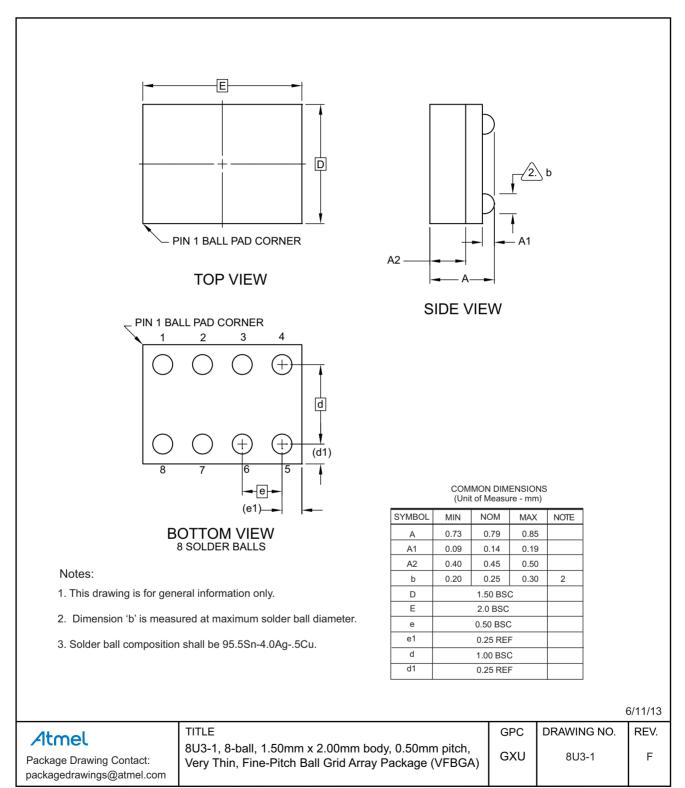


#### 13.6 5TS1 — 5-lead SOT23





### 13.7 8U3-1 — 8-ball VFBGA



# 14. Revision History

Doc. Rev.	Date	Comments
8719D	12/2016	Part marking SOT23: - Moved backside mark (YMXX) to front side line2. - Added @ = Country of Assembly.
8719C	01/2015	Add the UDFN Expanded Quantity Option. Update the 8X, 8MA2, 8P3, and 8U3-1 package outline drawings, the ordering information section, and the disclaimer page.
8719B	07/2013	Minor grammatical corrections. Update Atmel logos and template.
8719A	09/2010	Initial document release.



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